



Features

- Low Loss with High Rejection
- Low Group Delay Variation

Applications

Primarily for Radio Altimeter applications

Part Dimensions: 27.3 × 5.7 × 7.0 mm • 4.0 g Materials: Ag plated ceramic block with fused tin plated brass shield

Description

Surface mount ceramic bandpass filter. Superior rejection, insertion loss, reliability, as well as both peak and average power handling compared other bandpass filter technologies.

Electrical Specifications

Parameter	Frequency (MHz)	Typical at 25°C	Spec. at 25°C	Spec. over -55°C to +85°C
Nominal Impedance	-	50 ohms	-	-
Average Input Power	-	-	-	5.0 Watt max
Peak Input Power	-	-	-	50 Watt max
Input-Output Response				
Passband Insertion Loss	4250-4350	1.2 dB	1.4 dB max	1.6 dB max
	4225-4375	1.4 dB	1.6 dB max	1.8 dB max
	4200-4400	1.7 dB	2.0 dB max	2.2 dB max
Passband Return Loss	4200-4400	13 dB	12 dB min	12 dB min
Group Delay Variation	4250-4350	0.6 ns	1.0 ns max	1.0 ns max
	4225-4375	1.6 ns	2.0 ns max	2.0 ns max
Group Delay Minimum	4225-4375	5.1 ns	4.8 ns min	4.8 ns min
Group Delay Maximum	4225-4375	6.8 ns	7.3 ns max	7.3 ns max
Attenuation:	1 - 4000	58 dB	57 dB min	57 dB min
	4050	47 dB	40 dB min	40 dB min
	4100	34 dB	30 dB min	30 dB min
	4600-5000	56 dB	55 dB min	55 dB min
	5150-5950	53 dB	47 dB min	47 dB min

Note: CTS tests each unit to the critical specifications above. Subsequent audits may deviate due to repeatability among different test systems which shall not exceed these allowances. Specification Allowance
Insertion Loss 0.1 dB
Return Loss 1.0 dB
Attenuation 1.0 dB

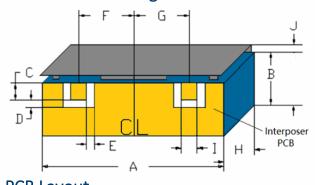
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CER0813P

4200-4400MHz Bandpass Filter

Mechanical Drawing



PCB Layout
8. 88 2 2 2 2 3 6 5 9 2 2 2 3 6 5 9 2 2 2 3 6 5 9 2 2 2 3 6 5 9 2 2 3 6 5 9 2 2 3 6 5 9 2 2 3 6 5 9 2 3 6
Shield Solder Resist Over Dielectric

Dim.	Nominal (mm)	Toleranc (±mm or Ma:
Α	27.30	max
В	4.30	max
С	1.14	0.13
D	1.02	0.13
Е	1.02	0.13
F	9.57	0.13
G	9.57	0.13
Н	7.00=6.2+0.8	max
I	1.14	0.13
J	5.70=4.3+1.4	max

IMPORTANT: Please assure >=30mils (0.75mm) thickness of dielectric beneath the I/O Pads <u>and</u> the surrounding clearance zone down to the required ground plane.

Please assure sufficient ground vias between the top metal ground plane and the primary ground plane.

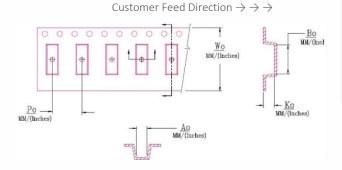
Recommended solder: 4-6 mils of SAC305 with reflow including 120s of soak at 217°C, and up to 30 sec peak at 241°C.

Packaging and Marking

Exposed Conductor

Dimension	Units	Spec.	Product Marking	
Reel Diameter	mm	330	CTS	
Reel Weight	kg	2.6	13P	
Reel Quantity	ea.	500	YWW	

Solder Resist Over Conductor



W_{o}	Ao	Bo	Ko	Po
1.732 in	0.24 in	1.087 in	0.256 in	0.472 in
44.0 mm	6.10 mm	27.60 mm	6.50 mm	12.0 mm

